



Vincotech

MiniSKiiP® PACK 2		1200 V / 70 A
Features		MiniSKiiP® 2 16 m
<ul style="list-style-type: none">• Solder less interconnection• Designed for motor drives up to 7 kW• Temperature sensor• Standard (6.5mm) and thin (2.8mm) lids, 16mm housing• Optional with pre-applied thermal grease		
Target applications		Schematic
<ul style="list-style-type: none">• Servo Drives• Industrial Motor Drives• UPS		
Types		
<ul style="list-style-type: none">• V23990-K230-F40-PM		



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	87	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	210	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	246	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150^\circ\text{C}$	10	μs
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	71	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $T_j = 150^\circ\text{C}$	430	A
Surge current capability	I^2t	$t_p = 10\text{ ms}$	925	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	154	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	5500	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance		With std lid For more informations see handling instructions	6,3	mm
Clearance		With std lid For more informations see handling instructions	6,3	mm
Comparative Tracking Index	CTI		> 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0024	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	V_{CEsat}		15		70	25 150	1,58	1,94 2,33	2,07 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			10	µA
Gate-emitter leakage current	I_{GES}		20	0		25			240	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{res}	$f = 1 \text{ MHz}$	0	25	25	25	4000		pF	
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g		15		0	25		540		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 2,5 \text{ W/mK}$ (HPTP)						0,39		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	± 15	600	70	25 150		97,6 98,4		ns
Rise time	t_r					25 150		21,4 26,8		ns
Turn-off delay time	$t_{d(off)}$					25 150		217,4 284,8		ns
Fall time	t_f					25 150		87,31 126,27		ns
Turn-on energy (per pulse)	E_{on}					25 150		3,74 6,38		mWs
Turn-off energy (per pulse)	E_{off}					25 150		4,09 6,63		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Inverter Diode

Static

Forward voltage	V_F				75	25 150		2,33 2,26	2,49 ⁽¹⁾ 2,42 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25 150		7000	120 14000	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 2,5$ W/mK (HPTP)						0,62		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=3024$ A/µs $di/dt=2913$ A/µs	± 15	600	70	25 150		66,85 85,41		A
Reverse recovery time	t_{rr}					25 150		128,62 311,52		ns
Recovered charge	Q_r					25 150		4,46 11,54		µC
Reverse recovered energy	E_{rec}					25 150		1,59 4,43		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 150		3099 606,24		A/µs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Thermistor

Static

Rated resistance	R					25		1		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1670 \Omega$				100	-2		2	%
Maximum Current	I_{max}							3		mA
Power dissipation constant	d					25		0,76		mW/K
A-value	A							$7,635 \times 10^{-3}$		1/K
B-value	B							$1,73 \times 10^{-5}$		$1/K^2$
Vincotech Thermistor Reference								E		

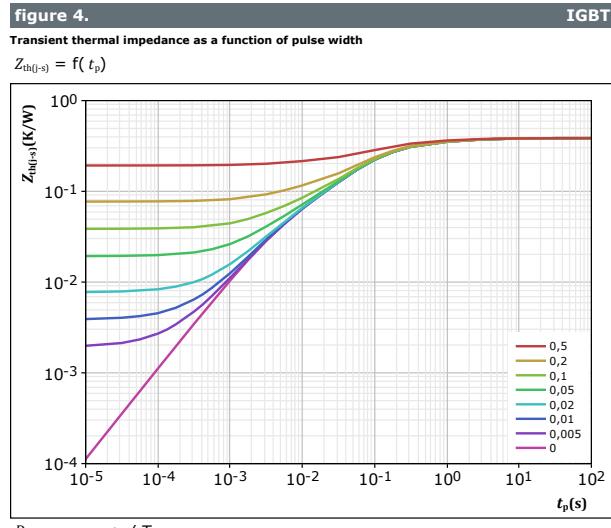
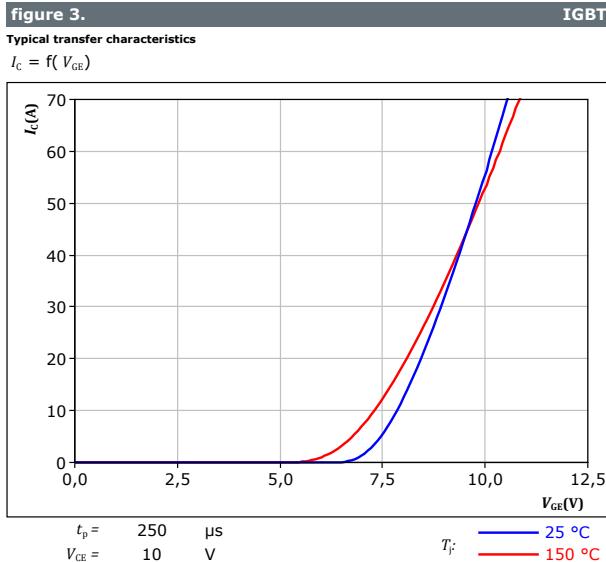
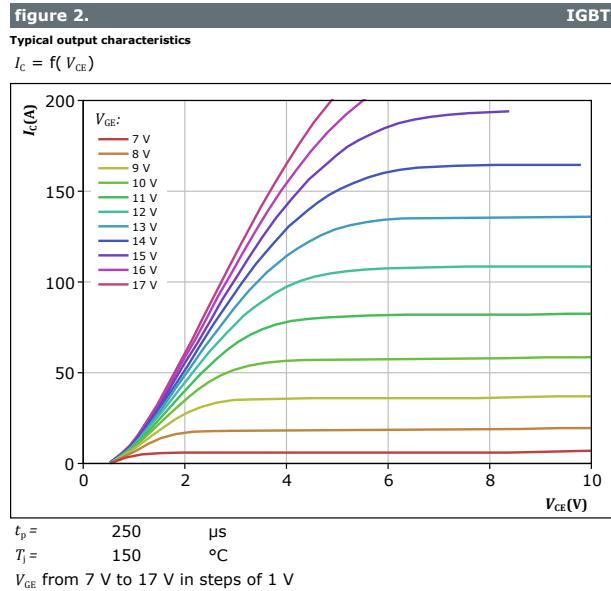
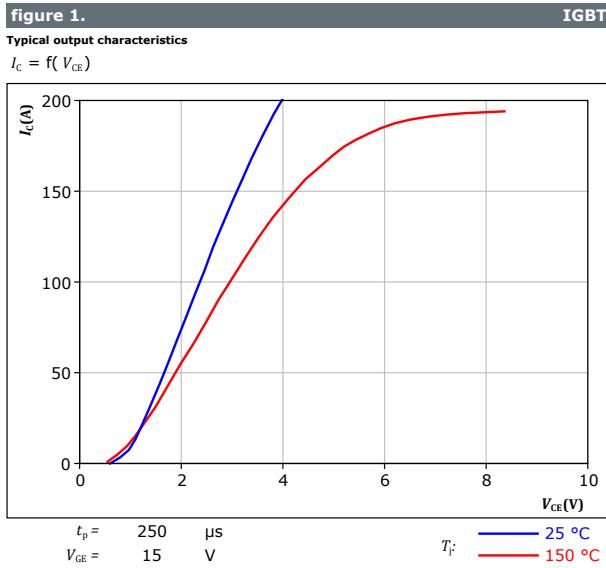
(¹) Value at chip level

(²) Only valid with pre-applied Vincotech thermal interface material.



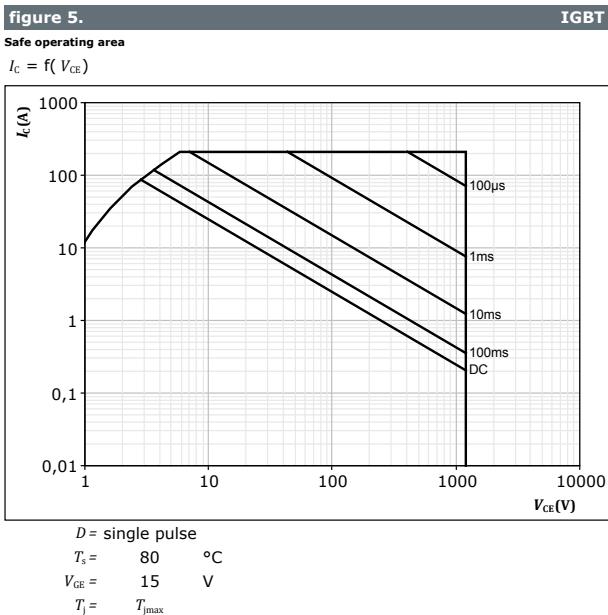
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Inverter Switch Characteristics





Inverter Switch Characteristics

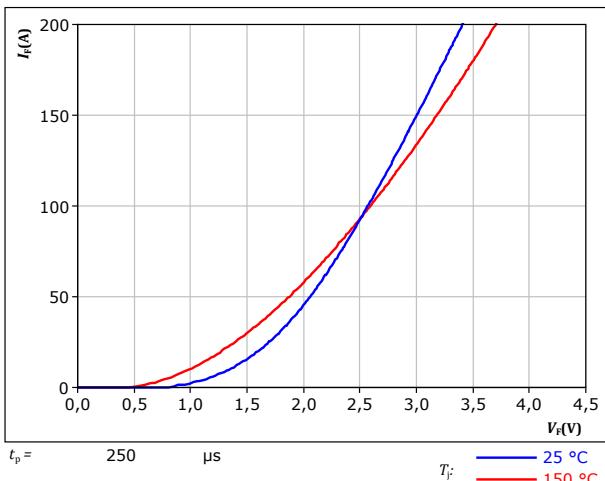


Inverter Diode Characteristics

figure 6.

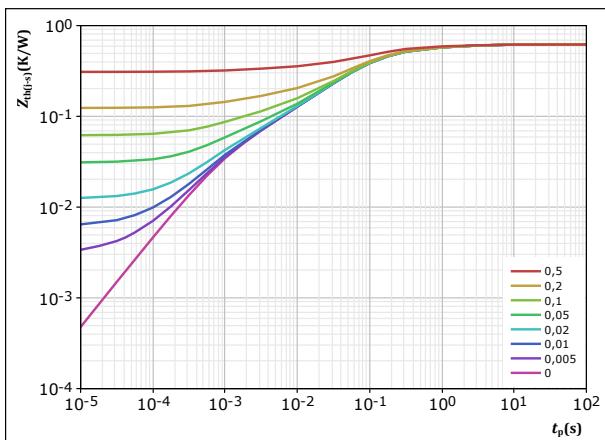
Typical forward characteristics

$$I_F = f(V_F)$$

**FWD****figure 7.**

Transient thermal impedance as a function of pulse width

$$Z_{th(f-s)} = f(t_p)$$

**FWD**

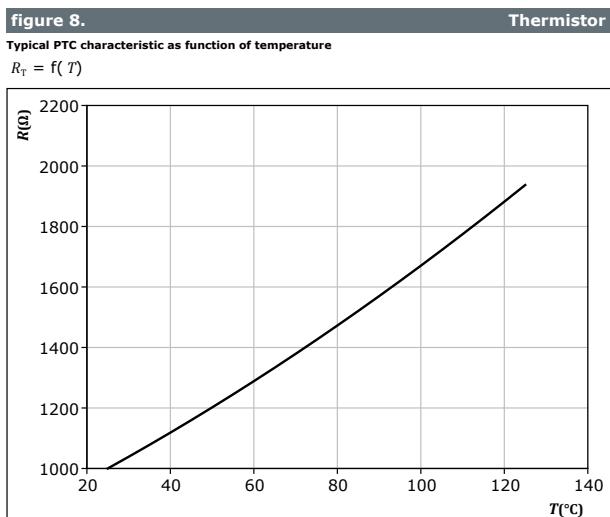
$$D = \frac{t_p / T}{0,618} \quad K/W$$

FWD thermal model values

R (K/W)	τ (s)
5,60E-02	2,33E+00
1,24E-01	3,33E-01
3,31E-01	7,46E-02
7,04E-02	9,60E-03
3,68E-02	1,03E-03



Thermistor Characteristics



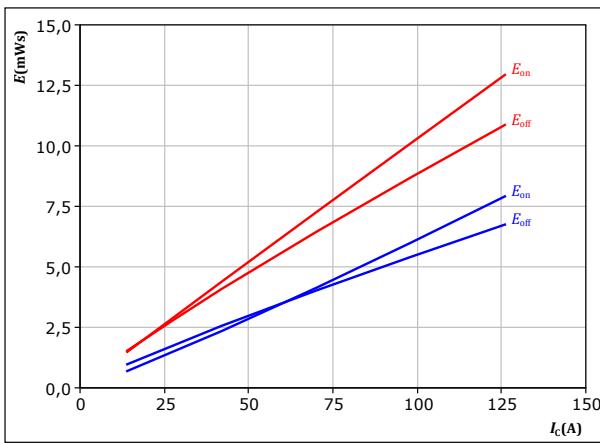


Inverter Switching Characteristics

figure 9.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 8 \quad \Omega \\ R_{goff} &= 8 \quad \Omega \end{aligned}$$

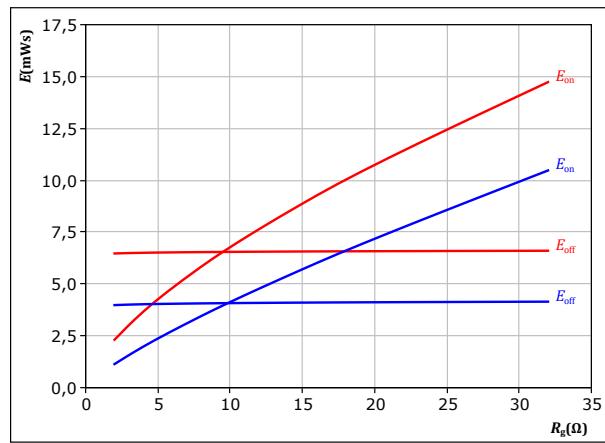
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 150^\circ\text{C} \end{array}$$

IGBT

figure 10.

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

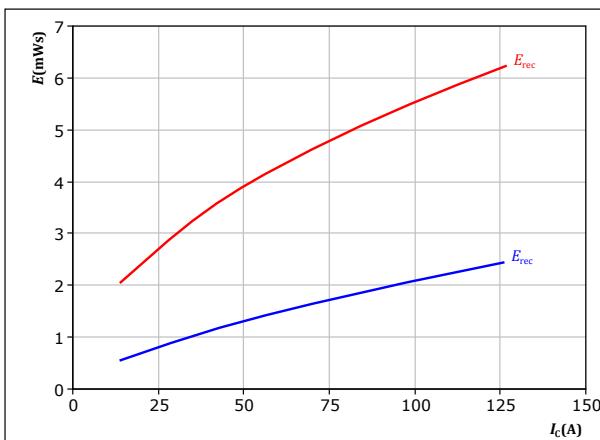
$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 70 \quad \text{A} \end{aligned}$$

IGBT

figure 11.

Typical reverse recovered energy loss as a function of collector current

$$E_{\text{rec}} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 8 \quad \Omega \end{aligned}$$

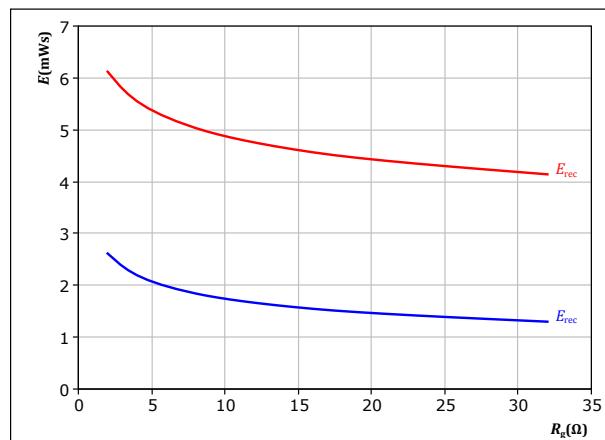
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 150^\circ\text{C} \end{array}$$

FWD

figure 12.

Typical reverse recovered energy loss as a function of gate resistor

$$E_{\text{rec}} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 70 \quad \text{A} \end{aligned}$$

FWD

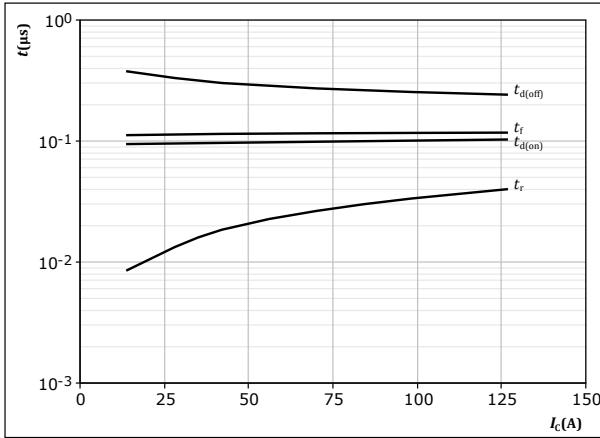


Inverter Switching Characteristics

figure 13.

Typical switching times as a function of collector current

$$t = f(I_C)$$



With an inductive load at

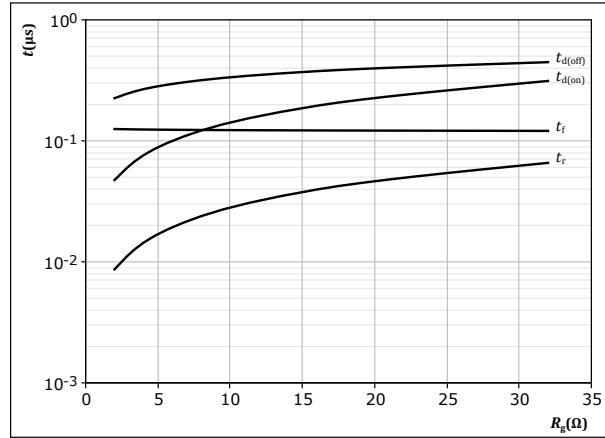
T _j =	150	°C
V _{CE} =	600	V
V _{GE} =	±15	V
R _{gon} =	8	Ω
R _{goff} =	8	Ω

IGBT

figure 14.

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



With an inductive load at

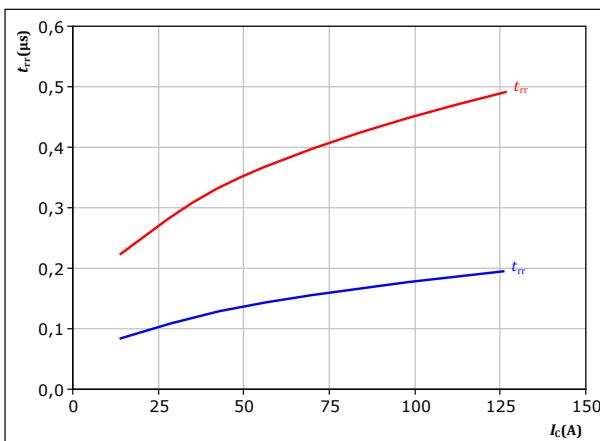
T _j =	150	°C
V _{CE} =	600	V
V _{GE} =	±15	V
I _C =	70	A

IGBT

figure 15.

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



With an inductive load at

V _{CE} =	600	V
V _{GE} =	±15	V
R _{gon} =	8	Ω

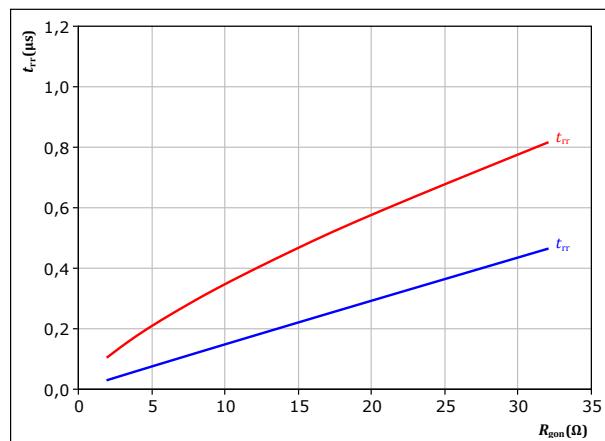
T_j: — 25 °C — 150 °C

FWD

figure 16.

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



With an inductive load at

V _{CE} =	600	V
V _{GE} =	±15	V
I _C =	70	A

T_j: — 25 °C — 150 °C



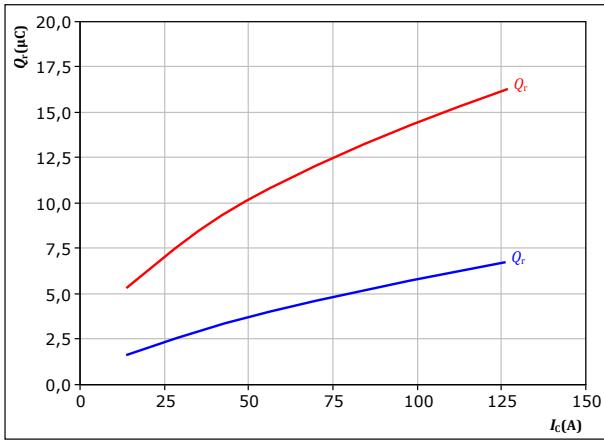
Inverter Switching Characteristics

figure 17.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 8 \quad \Omega \end{aligned}$$

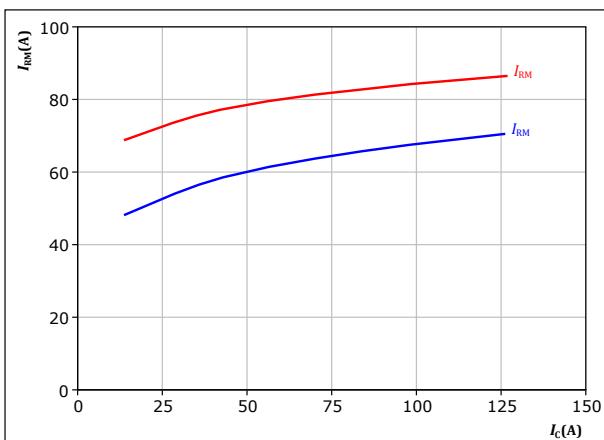
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 150^\circ\text{C} \end{array}$$

figure 19.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 8 \quad \Omega \end{aligned}$$

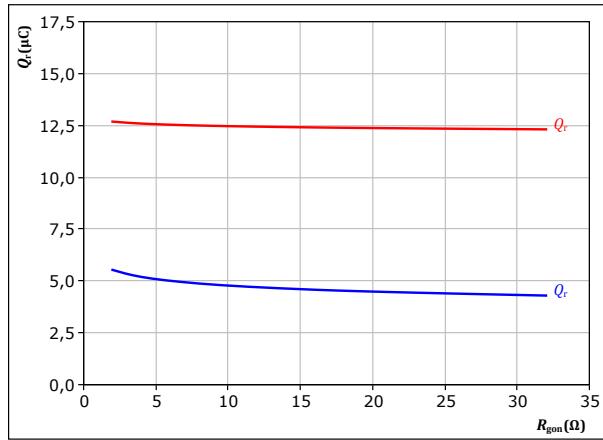
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 150^\circ\text{C} \end{array}$$

figure 18.

FWD

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 70 \quad \text{A} \end{aligned}$$

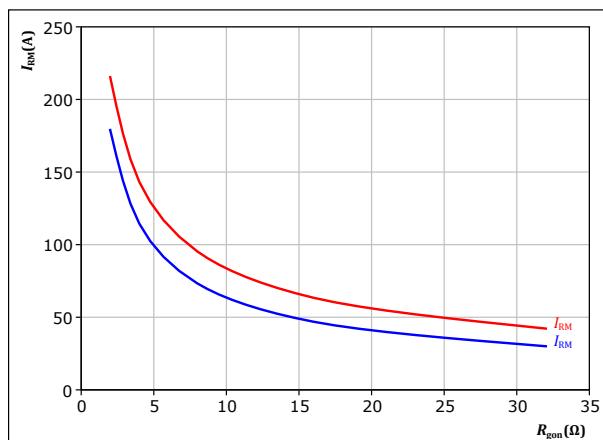
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 150^\circ\text{C} \end{array}$$

figure 20.

FWD

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

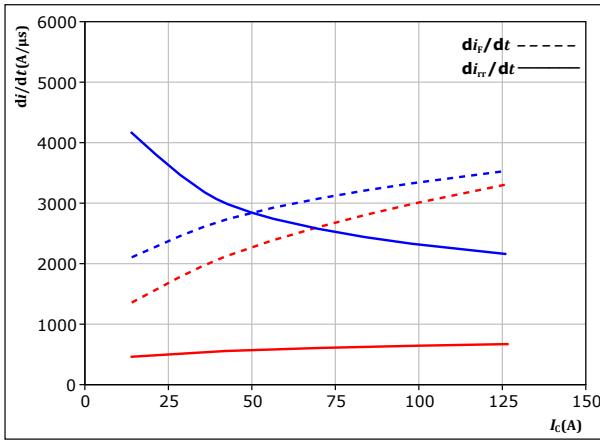
$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 70 \quad \text{A} \end{aligned}$$

$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 150^\circ\text{C} \end{array}$$

Inverter Switching Characteristics

figure 21. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



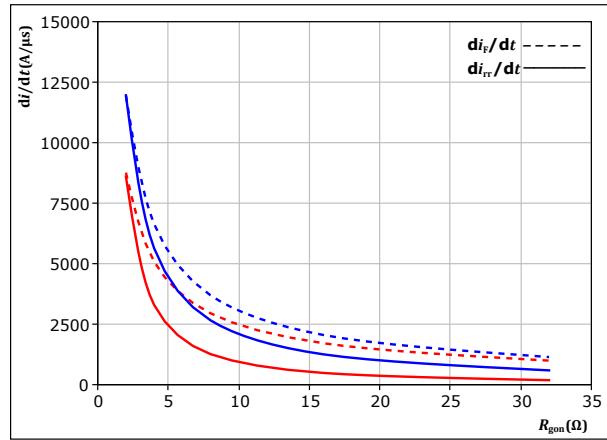
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

T_j : — 25 °C — 150 °C

figure 22. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

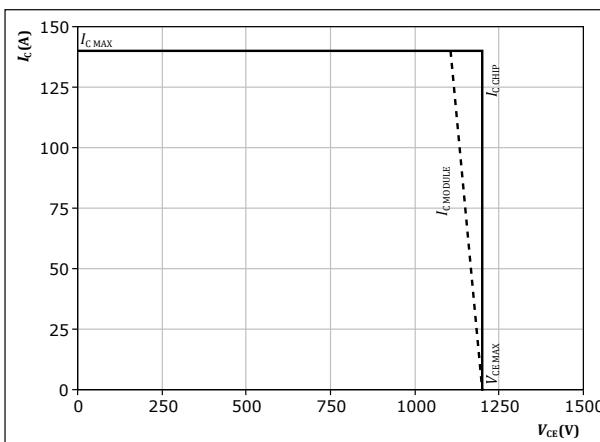
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 70$ A

T_j : — 25 °C — 150 °C

figure 23. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω



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Inverter Switching Definitions

figure 24. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

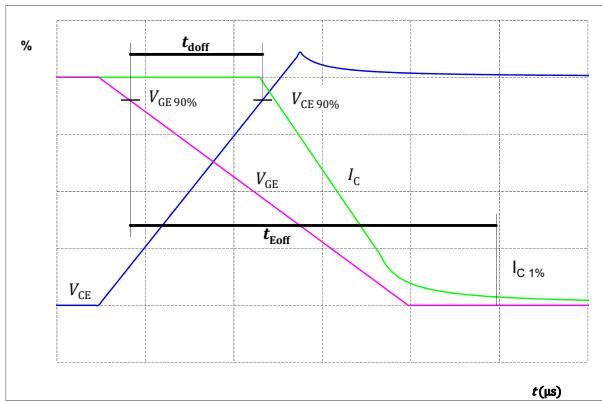


figure 26. IGBT

Turn-off Switching Waveforms & definition of t_f

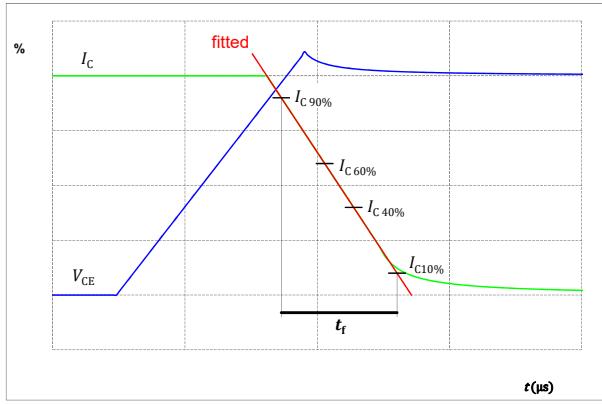


figure 25. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

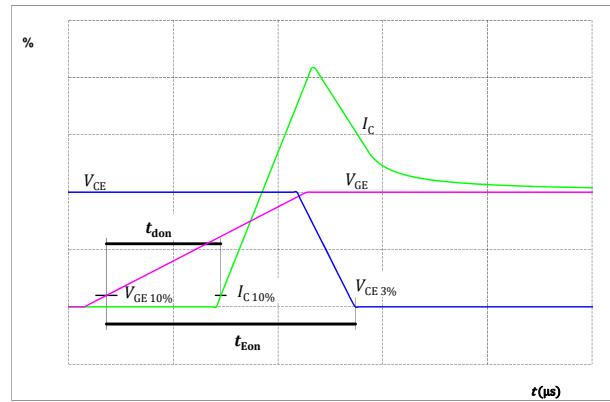
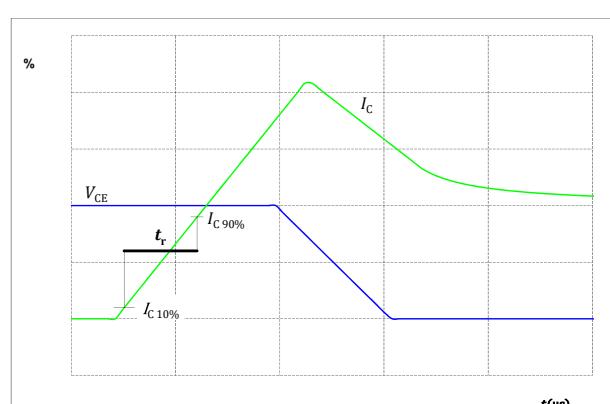


figure 27. IGBT

Turn-on Switching Waveforms & definition of t_r



Inverter Switching Definitions

figure 28.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

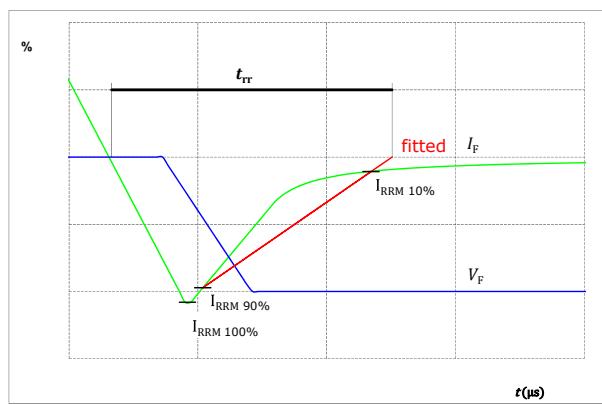
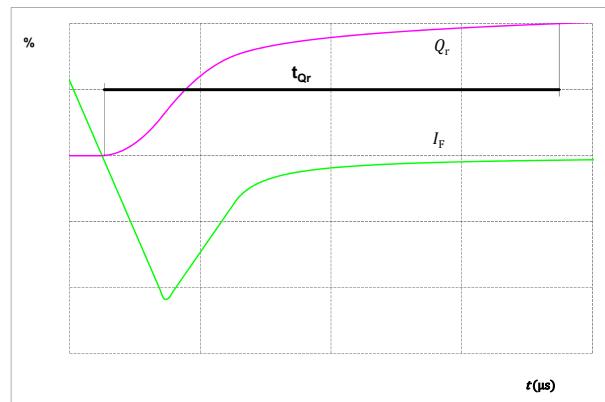


figure 29.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD



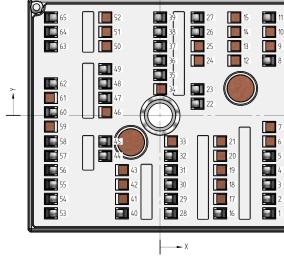


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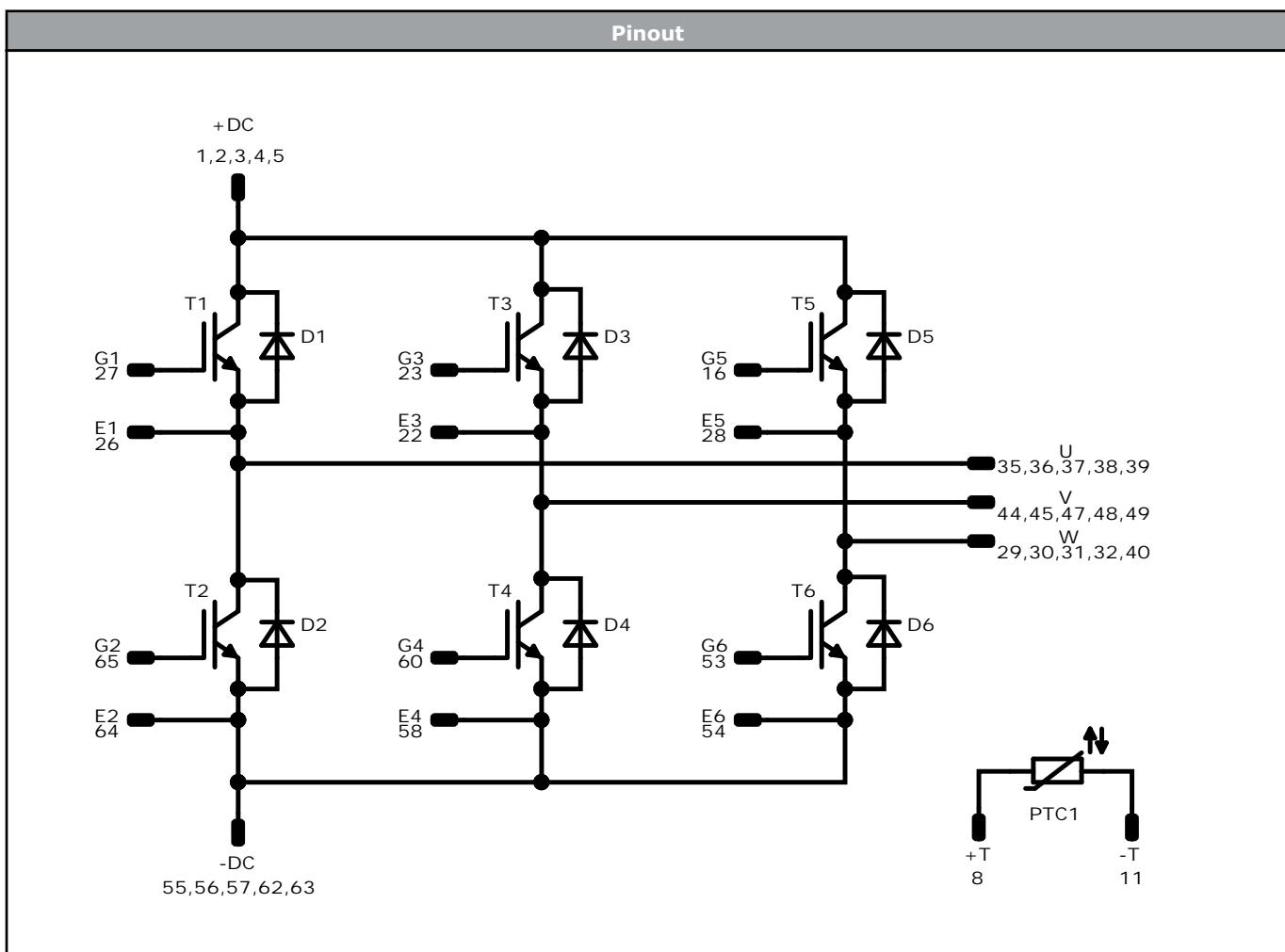
Ordering Code	
Version	Ordering Code
With std lid (6.5mm height) + no thermal grease	V23990-K230-F40-/0A/-PM
With thin lid (2.8mm height) + no thermal grease	V23990-K230-F40-/0B/-PM
With std lid (6.5mm height) + thermal grease (0,8 W/mK, P12, silicone-based)	V23990-K230-F40-/1A/-PM
With thin lid (2.8mm height) + thermal grease (0,8 W/mK, P12, silicone-based)	V23990-K230-F40-/1B/-PM
With std lid (6.5mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free)	V23990-K230-F40-/4A/-PM
With thin lid (2.8mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free)	V23990-K230-F40-/4B/-PM
With std lid (6.5mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based)	V23990-K230-F40-/5A/-PM
With thin lid (2.8mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based)	V23990-K230-F40-/5B/-PM

Marking						
Text	VIN	Date code	Type&Ver	UL	Lot	Serial
	VIN WWYY	WWYY	TTTTTTVV	UL	LLLL	SSSS
	Type&Ver	Lot number	Serial	Date code		
Datamatrix	TTTTTTVV	LLLLL	SSSS	WWYY		

Outline							
Pin table [mm]							
Pin	X	Y	Function	34	not assembled		
1	24,38	-21,8	+DC	35	0,03	9	U
2	24,38	-18,6	+DC	36	0,03	12,2	U
3	24,38	-15,4	+DC	37	0,03	15,4	U
4	24,38	-12,2	+DC	38	0,03	18,6	U
5	24,38	-9	+DC	39	0,03	21,8	U
6	not assembled		40	-8,5	-21,8	W	
7	not assembled		41	not assembled			
8	24,38	12,2	+T	42	not assembled		
9	not assembled		43	not assembled			
10	not assembled		44	-12,22	-9	V	
11	24,38	21,8	-T	45	-12,22	-5,8	V
12	not assembled		46	not assembled			
13	not assembled		47	-12,22	3,9	V	
14	not assembled		48	-12,22	7,1	V	
15	not assembled		49	-12,22	10,3	V	
16	13,42	-21,8	G5	50	not assembled		
17	not assembled		51	not assembled			
18	not assembled		52	not assembled			
19	not assembled		53	-24,38	-21,8	G6	
20	not assembled		54	-24,38	-18,6	E6	
21	not assembled		55	-24,38	-15,4	-DC	
22	8,38	2,6	E3	56	-24,38	-12,2	-DC
23	8,38	5,8	G3	57	-24,38	-9	-DC
24	not assembled		58	-24,38	-5,8	E4	
25	not assembled		59	not assembled			
26	8,38	18,6	E1	60	-24,38	0,7	G4
27	8,38	21,8	G1	61	not assembled		
28	2,46	-21,8	E5	62	-24,38	7,1	-DC
29	2,46	-18,6	W	63	-24,38	15,4	-DC
30	2,46	-15,4	W	64	-24,38	18,6	E2
31	2,46	-12,2	W	65	-24,38	21,8	G2
32	2,46	-9	W				
33	not assembled						



Pad positions refers to center point. For more informations on pad design please see package data



Identification					
ID	Component	Voltage	Current	Function	Comment
T2, T1, T4, T3, T6, T5	IGBT	1200 V	70 A	Inverter Switch	
D1, D2, D3, D4, D5, D6	FWD	1200 V	75 A	Inverter Diode	
Rt	PTC			Thermistor	



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Packaging instruction				
Standard packaging quantity (SPQ) 72	>SPQ	Standard	<SPQ	Sample

Handling instruction				
Handling instructions for MiniSKiiP® 2 packages see vincotech.com website.				

Package data				
Package data for MiniSKiiP® 2 packages see vincotech.com website.				

Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				

UL recognition and file number				
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.				

Document No.:	Date:	Modification:	Pages
V23990-K230-F40-PM-D4-14	01 Mar. 2019	Correction of Ic/If values	2
V23990-K230-F40-PM-D5-14	29 Oct. 2020	Thermal values correction	2,6,8

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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.